Product/Process Change Notifications

Amphenol ICC

PCN - 21 115

Amphenol Information Communication and Commercial Products Group

www.amphenol-icc.com

Release Date: October 12 2021

www.amphenol-icc.com				Release Date:	October	12	2021
Product Name:	D-Sub:HPL-569						
	DM Solder Bucket						
Product Manager:	Vicy Pulayath						
Subject:	Notification of Planned Change						
Distribution:	Affected customers						
Type of Change:	Documentation Change						
Change Description:	DM HE501 Series Male Solder type Connector dra Before Change CROSS REFERENCES HE501 and FC1 NE501 P/N FC1*P/N ACCESSORY HE501 NFAD D-MARY (1outing mounting) HE501 NEADS HE501 NEADS Description of Change. Description of Change.			After Change CROSS REFERENCES HE501 P/N FC1*P/N HE501M-(AP) D*M*x*P HE501F (AP) D*M*x*P HE501NoxAP HE501NoxAP HE501NoxAP	FRONT ACCESSORY without floating mounting		
Reason for Change:	HE501 part number to be corrected in drawing • "S" is wrongly denoted for male version. • Hence "AS" is to be replaced with "AP"						
Affected Parts:	See Affected Parts.xls file						
Effective Date of Change:	01 No	vember ,2021					
Last Time Buy Date:			1				
Earliest Disty Return Date:							
Last Time Shipment Date							
Datasheet Attached?	NA						
Qual/Test Data Attached?	NA						
Samples Availability Date:	20 October ,2021						
Available Alternatives?							
Questions?	Contact your local AICC Representative, or Product Manager Vicy Pulayath / Product Manager						
	Vicy.Pulayath@fci.com						

Note

Customers should contact Product Manager (or their local AICC Representative) directly regarding any concern on the PCN. Lack of any such customer feedback within three weeks of PCN release date will be interpreted as non-objection.